

PLEASE ENTER  
5/17/2007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/530,343 Confirmation No. : 7755  
First Named Inventor : Ralf LERNER, et al.  
Filed : April 6, 2005  
TC/A.U. : 2823  
Examiner : William D. Coleman  
  
Docket No. : 60291.000034  
Customer No. : 21967  
  
Title : TRENCH INSULATION IN SUBSTRATE DISKS COMPRISING  
LOGIC SEMICONDUCTORS AND POWER SEMICONDUCTORS

**AMENDMENT UNDER 37 C.F.R. § 1.312**

**MAIL STOP ISSUE FEE**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.312, Applicants submit the following Amendments.

Applicants respectfully request that the application be amended as set forth herein. The amendment is to expedite grant and does not introduce new issues.

**Amendments to the Claims** begin on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.